

L Number	Hits	Search Text	DB	Time stamp
-	29	"4885614"	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 15:59
-	5133	Hunt.in.	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 13:40
-	232	Hunt.in. and charles	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 13:40
-	0	(Hunt.in. and charles) and (silicon near3 germanium near3 carbide)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 13:40
-	6	(Hunt.in. and charles) and (silicon near3 germanium near3 carbon)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 13:45
-	672	((silicon adj2 germanium adj2 carbide) or (silicon adj2 germanium adj carbon) or Si-Ge-C or SiGeC)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 15:50
-	35	((silicon adj2 germanium adj2 carbide) or (silicon adj2 germanium adj carbon) or Si-Ge-C or SiGeC) same (etch\$3))	USPAT; US_PGPUB; EPO; JPO;	2002/08/13 15:52
-	2100	((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C)	DERWENT; IBM_TDB	
-	721	((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C)) and (etch\$3 or etchant\$1)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 16:04
-	15	((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C)) and ((etch\$3 or etchant\$1) same (HNA or KOH))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 16:03
-	60	((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C) and (HNA or KOH))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 16:05
-	10	((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C) and (HNA or KOH)) and ((silicon near2 germanium near2 carbide) or (silicon near2 germanium near2 carbon) or SiGeC or Si-Ge-C) same etch\$3)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 16:06
-	2999	MEMS	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/13 16:06

-	5124	cantilever adj (beam or rod)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/13 16:07
-	1200	cantilever adj (beam or rod) and (semiconductor or silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/13 16:08
-	4	(MEMS and ((cantilever adj (beam or rod)) and (semiconductor or silicon))) and (SiGe GeSi (Si near2 Ge) or (silicon near1 germanium))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/13 16:11
-	98	MEMS and (cantilever adj (beam or rod)) and (semiconductor or silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/13 16:12
-	4	(("4885614") or ("5357899") or ("5344524") or ("5413679")).PN.	USPAT	2002/08/21 10:43
-	21	4885614.urpn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/21 10:46
-	7	5357899.urpn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/21 10:46
-	22	5344524.urpn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/21 10:47
-	4	5413679.urpn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/08/21 10:47